

MD7007,A,B,F,BF MQ7007

**MD7007,A,B
CASE 654-07, STYLE 1**

**MD7007F,BF
CASE 610A-04, STYLE 1**

**MQ7007
CASE 607-04, STYLE 1**

**DUAL
AMPLIFIER TRANSISTOR
PNP SILICON**

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MAXIMUM RATINGS

Rating	Symbol	Value		Unit
Collector-Emitter Voltage	V_{CEO}	40		Vdc
Collector-Base Voltage	V_{CBO}	50		Vdc
Emitter-Base Voltage	V_{EBO}	5.0		Vdc
Collector Current — Continuous	I_C	200		mAdc
		All Die Equal Power		
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ MD7007,A,B MD7007F,BF MQ7007	P_D	675 350 400	625 400 600	mW
Derate above 25°C MD7007,A,B MD7007F,BF MQ7007		3.29 2.0 2.28	3.57 2.28 3.42	$\text{mW}/^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ MD7007,A,B MD7007F,BF MQ7007	P_D	1.8 1.0 0.9	2.5 2.0 3.6	Watts
Derate above 25°C MD7007,A,B MD7007F,BF MQ7007		10.3 5.71 5.13	14.3 11.4 20.5	$\text{mW}/^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	One Die	All Die Equal Power	Unit
Thermal Resistance, Junction to Case MD7007,A,B MD7007F,BF MQ7007	$R_{\theta JC}$	97 175 195	70 87.5 48.8	°C/W
Thermal Resistance, Junction to Ambient MD7007,A,B MD7007F,BF MQ7007	$R_{\theta JA}(1)$	304 500 438	280 438 292	°C/W
		Junction to Ambient	Junction to Case	
Coupling Factors MD7007,A,B MD7007F,BF MQ7007 (Q1-Q2) (Q1-Q2 or Q1-Q4)		84 75 57 55	44 0 0 0	%

(1) $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS(2)					
Collector-Emitter Breakdown Voltage(2) ($I_C = 10 \mu\text{Adc}, I_B = 0$)	$V_{(BR)CEO}$	40	—	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 10 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	50	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	5.0	—	—	Vdc
Collector Cutoff Current ($V_{CB} = 30 \text{ Vdc}, I_E = 0$)	I_{CBO}	—	—	100	nAdc
ON CHARACTERISTICS(2)					
DC Current Gain ($I_C = 100 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h_{FE}	30 30 30 15	110 130 75 25	— — — —	—

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ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Collector-Emitter Saturation Voltage ($I_C = 50 \text{ mA}_\text{dc}$, $I_B = 5.0 \text{ mA}_\text{dc}$)	$V_{CE(\text{sat})}$	—	0.38	1.0	Vdc
Base-Emitter Saturation Voltage ($I_C = 50 \text{ mA}_\text{dc}$, $I_B = 5.0 \text{ mA}_\text{dc}$)	$V_{BE(\text{sat})}$	—	0.9	1.5	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product(2) ($I_C = 10 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 100 \text{ MHz}$)	f_T	300	600	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}$, $I_E = 0$, $f = 100 \text{ kHz}$)	C_{obo}	—	4.0	8.0	pF
Input Capacitance ($V_{BE} = 2.0 \text{ Vdc}$, $I_C = 0$, $f = 100 \text{ kHz}$)	C_{ibo}	—	3.8	10	pF
MATCHING CHARACTERISTICS					
DC Current Gain Ratio(3) ($I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	MD7007A MD7007B	h_{FE1}/h_{FE2}	-0.75 0.85	— —	1.0 1.0
Base-Emitter Voltage Differential ($I_C = 1.0 \text{ mA}_\text{dc}$, $V_{CE} = 10 \text{ Vdc}$)	MD7007A MD7007B	$ V_{BE1}-V_{BE2} $	— —	— —	20 10
					mVdc

(2) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

(3) The lowest h_{FE} reading is taken as h_{FE1} for this ratio.